

TOSHIBA Transistor Silicon NPN Epitaxial Planar Type (PCT process)

## 2SC2714

High Frequency Amplifier Applications

FM, RF, MIX, IF Amplifier Applications

Unit: mm

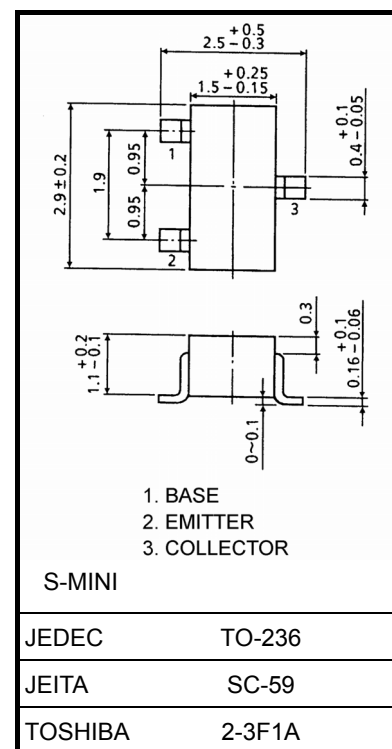
- Small reverse transfer capacitance:  $C_{re} = 0.7$  pF (typ.)
- Low noise figure: NF = 2.5dB (typ.)

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Rating	Unit
Collector-base voltage	$V_{CBO}$	40	V
Collector-emitter voltage	$V_{CEO}$	30	V
Emitter-base voltage	$V_{EBO}$	4	V
Collector current	$I_C$	20	mA
Base current	$I_B$	4	mA
Collector power dissipation	$P_C$	100	mW
Junction temperature	$T_j$	125	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-55 to 125	$^\circ\text{C}$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



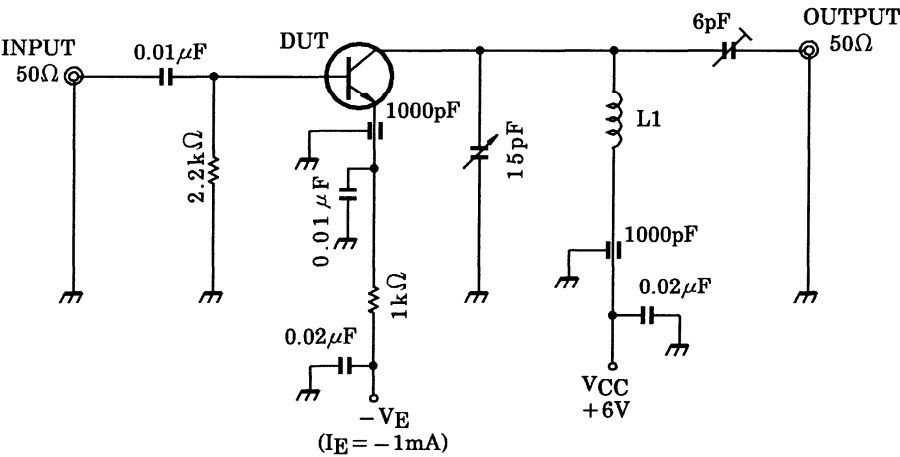
Weight: 12 mg (typ.)

### Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	$I_{CBO}$	$V_{CB} = 40$ V, $I_E = 0$	—	—	0.5	$\mu\text{A}$
Emitter cut-off current	$I_{EBO}$	$V_{EB} = 4$ V, $I_C = 0$	—	—	0.5	$\mu\text{A}$
DC current gain	$h_{FE}$ (Note)	$V_{CE} = 6$ V, $I_C = 1$ mA	40	—	200	—
Reverse transfer capacitance	$C_{re}$	$V_{CB} = 6$ V, $f = 1$ MHz	—	0.70	—	pF
Transition frequency	$f_T$	$V_{CE} = 6$ V, $I_C = 1$ mA	—	550	—	MHz
Collector-base time constant	$C_{c-rbb'}$	$V_{CB} = 6$ V, $I_E = -1$ mA, $f = 30$ MHz	—	—	30	ps
Noise figure	NF	$V_{CC} = 6$ V, $I_E = -1$ mA, $f = 100$ MHz,	—	2.5	5.0	dB
Power gain	$G_{pe}$	Figure 1	17	23	—	dB

Note:  $h_{FE}$  classification R: 40 to 80, O: 70 to 140, Y: 100 to 200

Start of commercial production  
1982-10



L1: 0.8 mmφ silver plated copper wire, 4T, 10ID, 8 length

Figure1 NF, G<sub>pe</sub> Test Circuit

y Parameter (typ.)

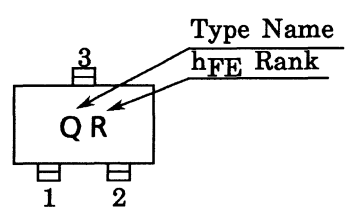
(1) Common emitter ( $V_{CE} = 6\text{ V}$ ,  $I_E = -1\text{ mA}$ ,  $f = 100\text{ MHz}$ ,  $T_a = 25^\circ\text{C}$ )

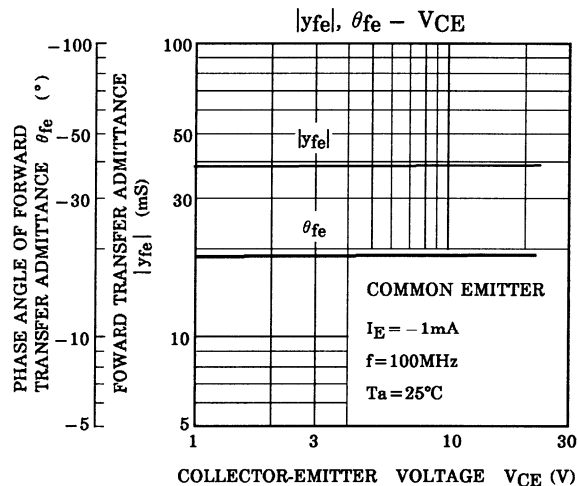
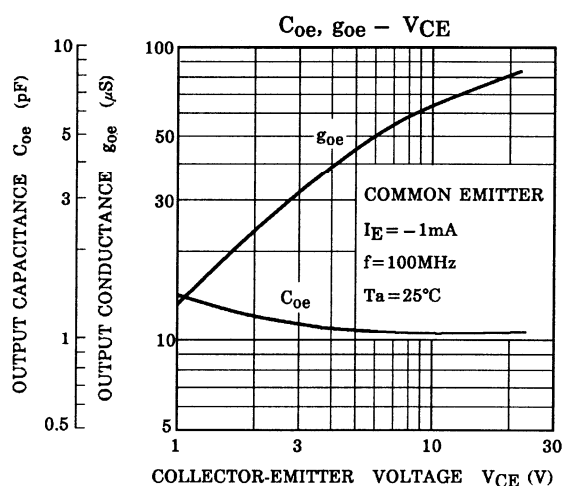
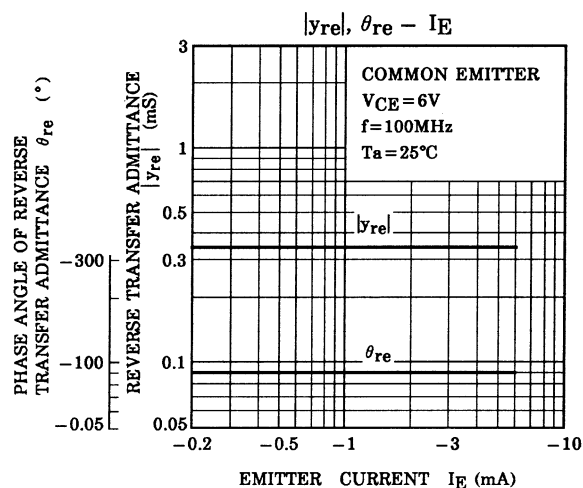
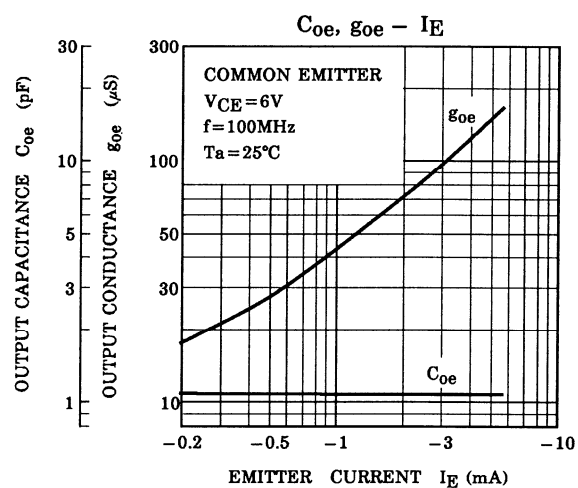
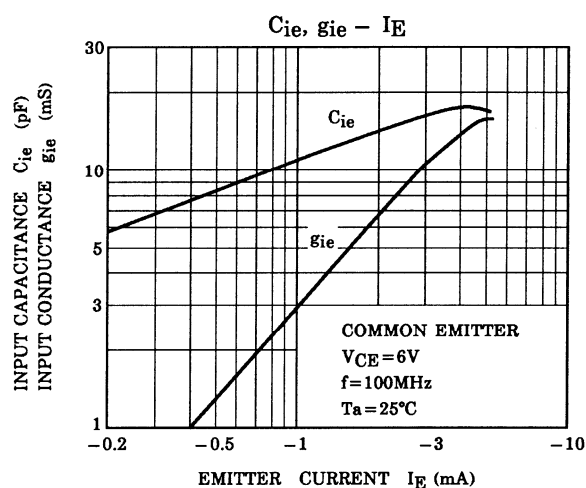
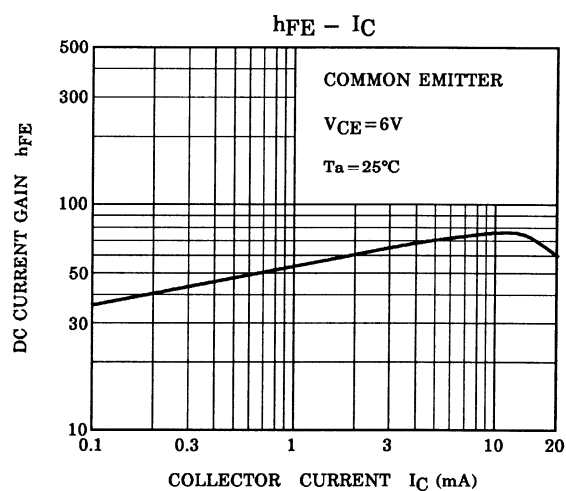
Characteristics	Symbol	Typ.	Unit
Input conductance	$g_{ie}$	2.9	mS
Input capacitance	$C_{ie}$	10.2	pF
Reverse transfer admittance	$ y_{re} $	0.33	mS
Phase angle of reverse transfer admittance	$\theta_{re}$	-90	°
Forward transfer admittance	$ y_{fe} $	40	mS
Phase angle of forward transfer admittance	$\theta_{fe}$	-20	°
Output conductance	$g_{oe}$	45	μS
Output capacitance	$C_{oe}$	1.1	pF

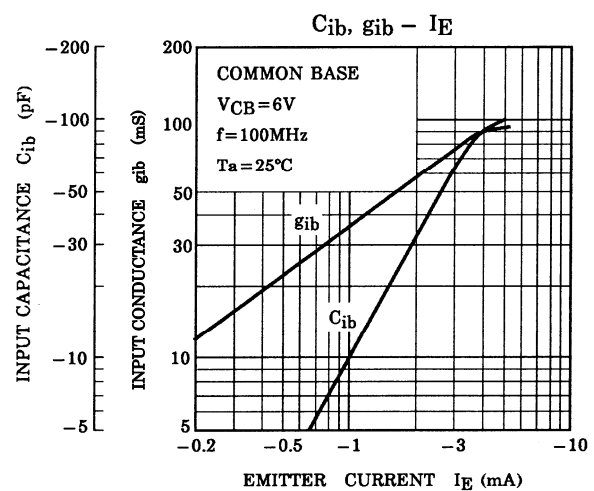
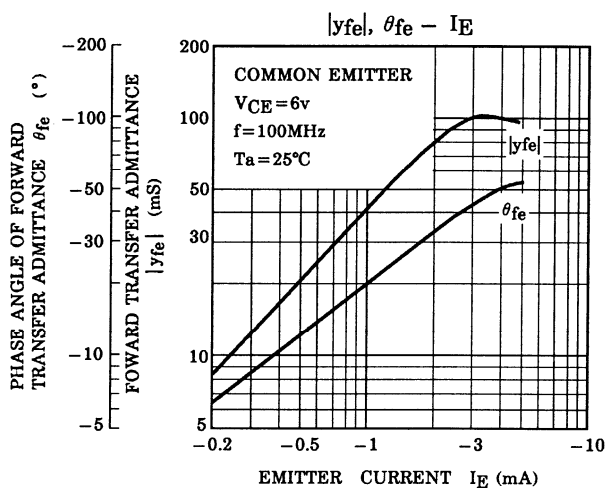
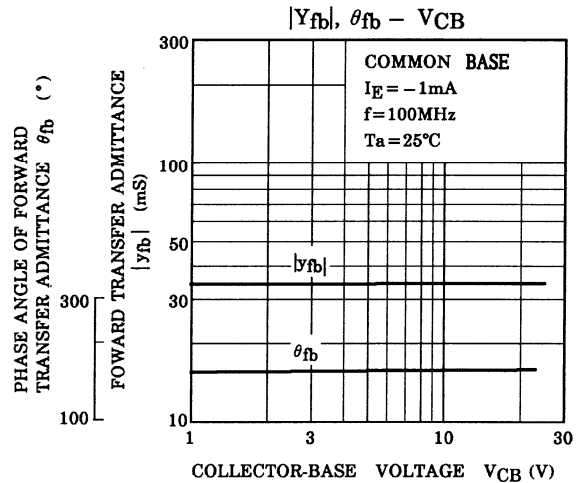
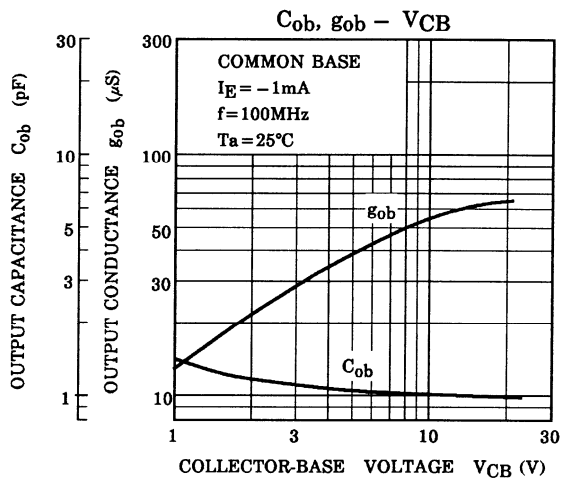
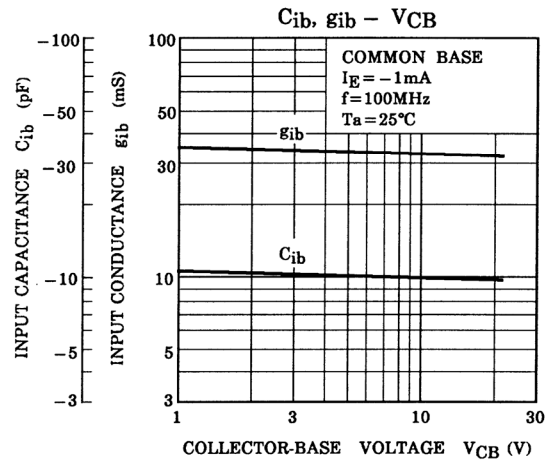
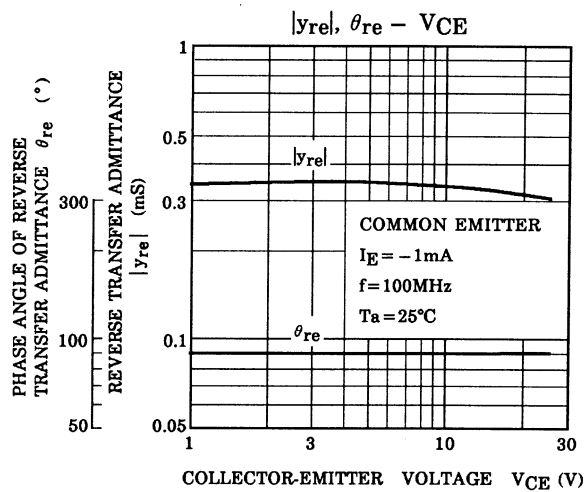
(2) Common base ( $V_{CE} = 6\text{ V}$ ,  $I_E = -1\text{ mA}$ ,  $f = 100\text{ MHz}$ ,  $T_a = 25^\circ\text{C}$ )

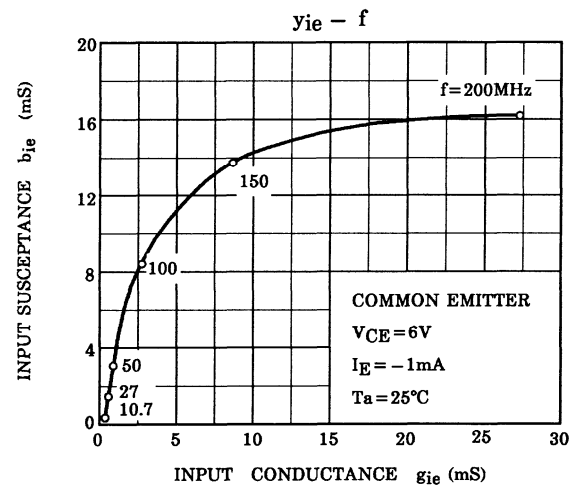
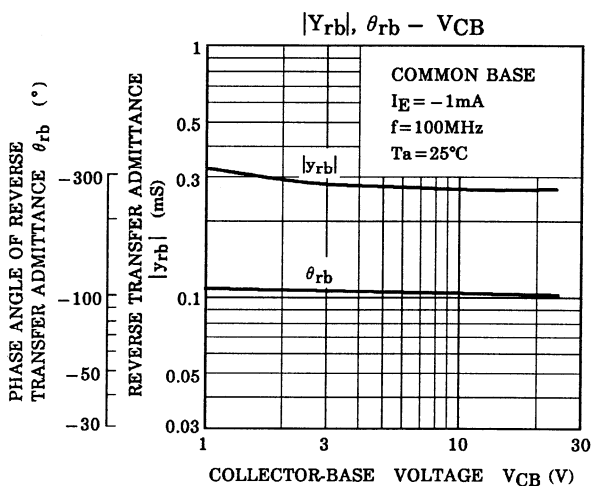
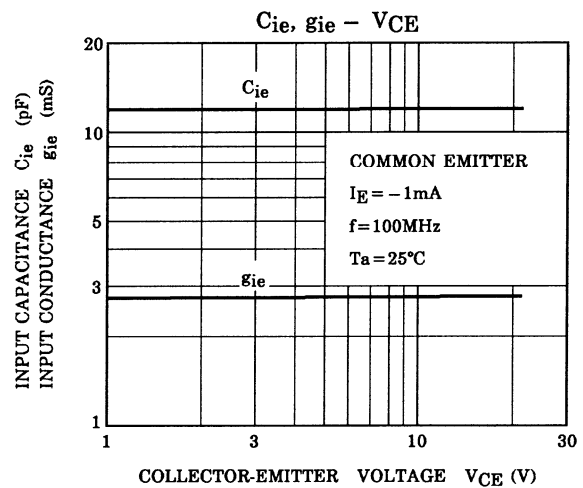
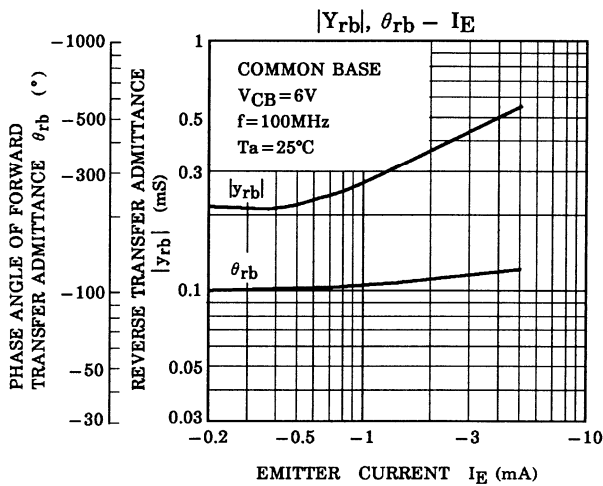
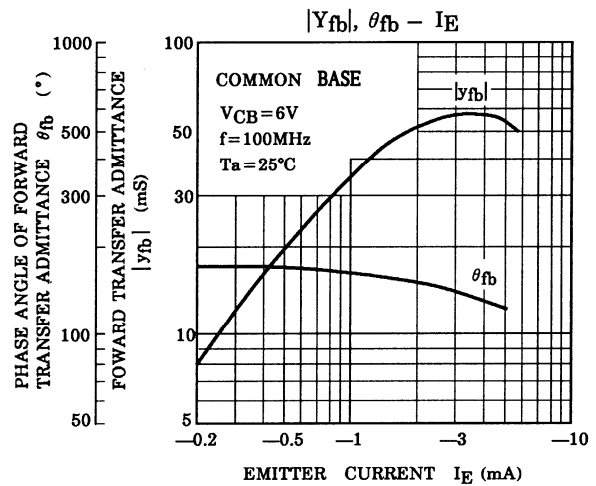
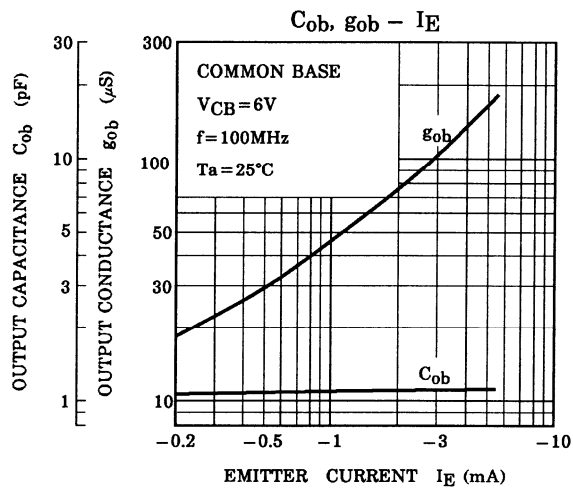
Characteristics	Symbol	Typ.	Unit
Input conductance	$g_{ib}$	34	mS
Input capacitance	$C_{ib}$	-10	pF
Reverse transfer admittance	$ y_{rb} $	0.27	mS
Phase angle of reverse transfer admittance	$\theta_{rb}$	-105	°
Forward transfer admittance	$ y_{fb} $	34	mS
Phase angle of forward transfer admittance	$\theta_{fb}$	165	°
Output conductance	$g_{ob}$	45	μS
Output capacitance	$C_{ob}$	1.1	pF

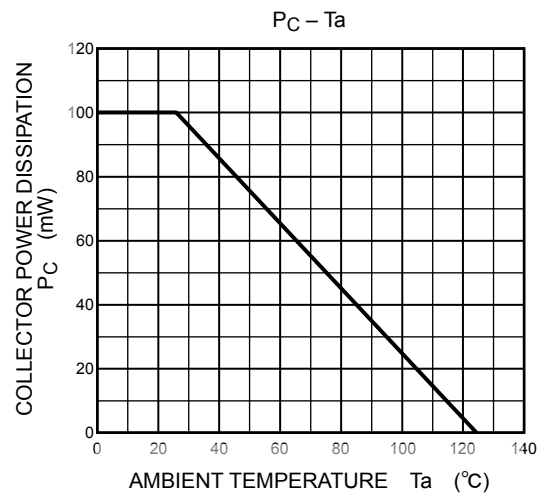
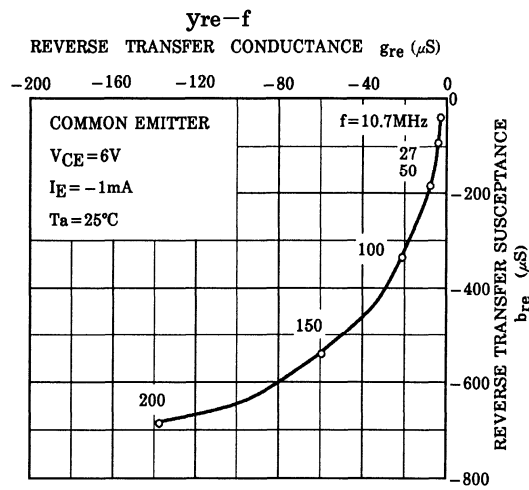
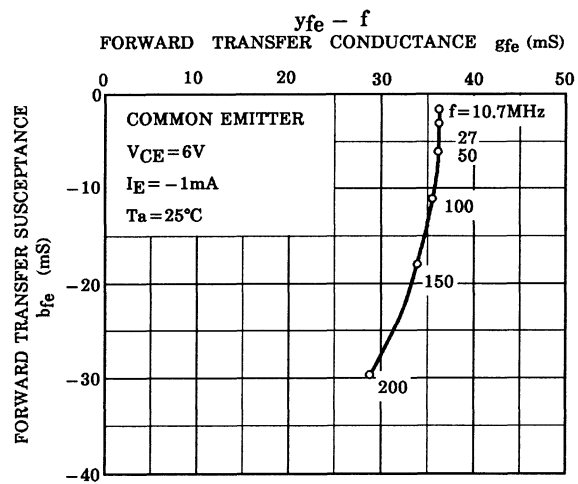
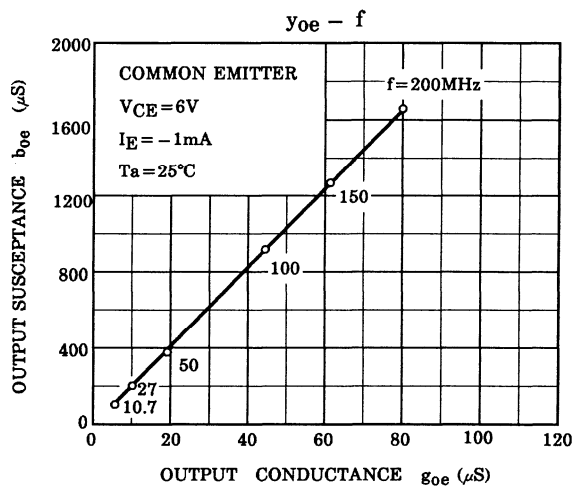
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